

DATE OF ISSUE: 2007. 09. 14

SPECIFICATION

MODEL: SLHNNWW629T1

HIGH POWER LED PKG -SUNNIX

CUSTOMER:

SAMSUNG ELECTRO-MECHANICS							
DRAWN	CHECKED	APPROVED					

CUSTOMER						
CHECKED	CHECKED	APPROVED				

SAMSUNG ELECTRO-MECHANICS CO,.LTD. 314, MAETAN3-DONG, YEONGTONG-GU, SUWON, GYEONGGI-DO,KOREA,443-743



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Product Outline

□ Features

- Plastic Molded Lead Frame Type (8.0 × 8.0 × 3.9mm³)
- · High CRI & Luminous Intensity LED
- · Built In 9 LED Chips
- Beam View Angle(△θ): 120°
- · Lead(Pb) Free Product RoHS Compliant

Applications

· General Illumination

Down Lighting

Decorative Lighting

■ Rating and Characteristics

☐ Absolute Maximum Rating(Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	16.5	V
Operating Temperature	Topr	-40 ~ 85	$^{\circ}$
Storage Temperature	Tstg	-40 ~ 110	$^{\circ}$
Soldering Temperature	Tsol	260(for 5 second)	Ĉ
Power Dissipation	Pd	1.8	W
Forward Current, DC	lF	180	mA

☐ Electro-Optical Characteristics(Ta=25°C)

Parameter	Symbol	Rank	Min.	Тур.	Max.	Unit	Conditions
Reverse Voltage	VR	-	12.0	ı	16.5	٧	IR=10 ^{mA}
Forward Voltage	VF	S0	8.9	-	11.0	V	
Luminous Flux	Ф۷	S0	80	95	150	lm	IF=180 ^{mA}
Color Temperature	ССТ	-	2600	-	5000	К	

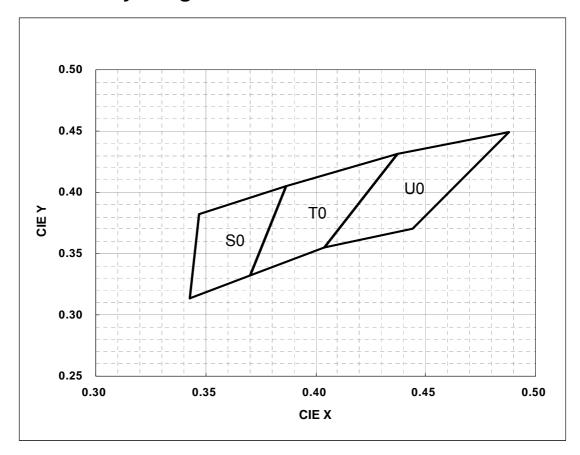
Chromaticity Coordinate(CIE)

Rank	х				у			Condition	
S0	0.3428	0.3700	0.3863	0.3471	0.3138	0.3322	0.4050	0.3818	
T0	0.3700	0.4041	0.4370	0.3863	0.3322	0.3551	0.4310	0.4050	IF=180 ^{mA}
U0	0.4041	0.4440	0.4880	0.4370	0.3551	0.3700	0.4490	0.4310	

* Tolerance : V_F : ±0.1, Φv : ±10%, CCx CCy : ±0.02

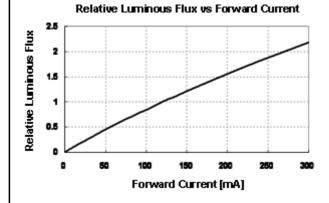


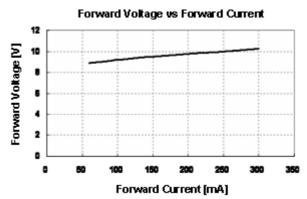
■ Chromaticity Diagram

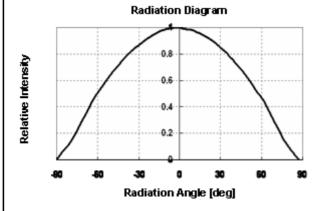


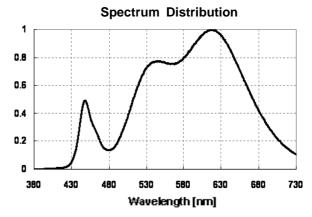


■ Typical Characteristics Graph







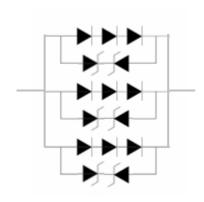


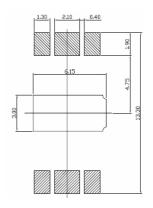


Package Outline Dimensions Unit:mm Tolerance:±0.2 1.80 2.90 8,00 1.50 0.90 Cathode Mark 13.00 8.00 (B)Pick and Place 1. Do not place pressure on the encapsulating resin ("A"). 0.80 1,00 2. The maximum compressing force is 15N on the polymer("B").

Circuit

Solder Pattern for Surface Mount





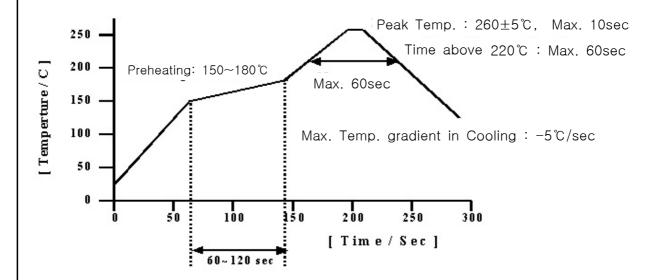
Remarks)

Make sure the heat sink is electrically connected to the Anode. Heat sink is to be soldered, If not, use the heat conductive adhesive



■ Solder Conditions

1) Reflow Conditions (Pb-Free Solder, Sn-Ag-Cu Series recommended)



2) For Manual Soldering

Not more than 5 seconds @MAX300℃, under soldering iron.



Precaution for Use

- 1) For over-current-proof function, customers are recommended to apply resistors to prevent sudden change of the current caused by slight shift of the voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc.

When washing is required, IPA is recommended to use.

- 3) When the LEDs illuminate, operating current should be decided after considering the ambient maximum temperature.
- 4) LEDs must be stored in a clean environment.

 If the LEDs are to be stored for 3 months or more after being shipped from SEMCO, they should be packed by a sealed container with nitrogen gas injected.

 (Shelf life of sealed bags: 12 months, temp. 0~40°C, 20~70%RH)
- 5) After storage bag is open, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 168 hours (7 days) at an assembly line with a condition of no more than 30° C/60%RH,
 - b. Stored at <10% RH.
- 6) Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >65% at 23±5°C.
- 8) Devices must be baked for 24hours at 65±5°C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices.

Damaged LEDs may show some unusual characteristics such as increase in leak current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.



Revision History (Model:SLHNNWW629T1)

Date	Revision History	Author			
Date	izevision i listory	Drawn	Approved		
2007.09.14	Initial Edition - Preliminary	R.S.Park	S.K.Lee		